

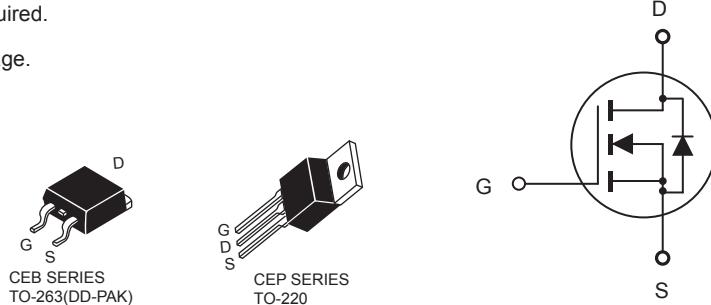


CEP60N10/CEB60N10

N-Channel Enhancement Mode Field Effect Transistor

FEATURES

- 100V, 57A, $R_{DS(ON)} = 24m\Omega$ @ $V_{GS} = 10V$.
- Super high dense cell design for extremely low $R_{DS(ON)}$.
- High power and current handling capability.
- Lead free product is acquired.
- TO-220 & TO-263 package.



ABSOLUTE MAXIMUM RATINGS $T_C = 25^\circ C$ unless otherwise noted

| Parameter | Symbol | Limit | Units |
|---|----------------|------------|--------------------|
| Drain-Source Voltage | V_{DS} | 100 | V |
| Gate-Source Voltage | V_{GS} | ± 20 | V |
| Drain Current-Continuous | I_D | 57 | A |
| Drain Current-Pulsed ^a | I_{DM} | 228 | A |
| Maximum Power Dissipation @ $T_C = 25^\circ C$ - Derate above $25^\circ C$ | P_D | 200 1.3 | W W/ $^\circ C$ |
| Single Pulsed Avalanche Energy ^d | E_{AS} | 290 | mJ |
| Single Pulsed Avalanche Current ^d | I_{AS} | 29 | A |
| Operating and Store Temperature Range | T_J, T_{stg} | -55 to 175 | $^\circ C$ |

Thermal Characteristics

| Parameter | Symbol | Limit | Units |
|---|-----------------|-------|--------------|
| Thermal Resistance, Junction-to-Case | $R_{\theta JC}$ | 0.75 | $^\circ C/W$ |
| Thermal Resistance, Junction-to-Ambient | $R_{\theta JA}$ | 62.5 | $^\circ C/W$ |

This is preliminary information on a new product in development now .
Details are subject to change without notice .

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<http://www.cetsemi.com>



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Electrical Characteristics $T_C = 25^\circ\text{C}$ unless otherwise noted

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| Parameter | Symbol | Test Condition | Min | Typ | Max | Units |
|---|----------------------------|--|-----|------|-----|------------------|
| Off Characteristics | | | | | | |
| Drain-Source Breakdown Voltage | BV_{DSS} | $V_{\text{GS}} = 0\text{V}, I_D = 250\mu\text{A}$ | 100 | | | V |
| Zero Gate Voltage Drain Current | I_{DSS} | $V_{\text{DS}} = 80\text{V}, V_{\text{GS}} = 0\text{V}$ | | 1 | | μA |
| Gate Body Leakage Current, Forward | I_{GSSF} | $V_{\text{GS}} = 20\text{V}, V_{\text{DS}} = 0\text{V}$ | | 100 | | nA |
| Gate Body Leakage Current, Reverse | I_{GSSR} | $V_{\text{GS}} = -20\text{V}, V_{\text{DS}} = 0\text{V}$ | | -100 | | nA |
| On Characteristics^b | | | | | | |
| Gate Threshold Voltage | $V_{\text{GS}(\text{th})}$ | $V_{\text{GS}} = V_{\text{DS}}, I_D = 250\mu\text{A}$ | 2 | | 4 | V |
| Static Drain-Source On-Resistance | $R_{\text{DS}(\text{on})}$ | $V_{\text{GS}} = 10\text{V}, I_D = 30\text{A}$ | | 20 | 24 | $\text{m}\Omega$ |
| Forward Transconductance | g_{FS} | $V_{\text{DS}} = 15\text{V}, I_D = 30\text{A}$ | | 26 | | S |
| Dynamic Characteristics^c | | | | | | |
| Input Capacitance | C_{iss} | $V_{\text{DS}} = 25\text{V}, V_{\text{GS}} = 0\text{V}, f = 1.0 \text{ MHz}$ | | 2810 | | pF |
| Output Capacitance | C_{oss} | | | 440 | | pF |
| Reverse Transfer Capacitance | C_{rss} | | | 38 | | pF |
| Switching Characteristics^c | | | | | | |
| Turn-On Delay Time | $t_{\text{d}(\text{on})}$ | $V_{\text{DD}} = 50\text{V}, I_D = 30\text{A}, V_{\text{GS}} = 10\text{V}, R_{\text{GEN}} = 2.5\Omega$ | | 26 | 52 | ns |
| Turn-On Rise Time | t_r | | | 5 | 10 | ns |
| Turn-Off Delay Time | $t_{\text{d}(\text{off})}$ | | | 52 | 104 | ns |
| Turn-Off Fall Time | t_f | | | 8 | 16 | ns |
| Total Gate Charge | Q_g | $V_{\text{DS}} = 80\text{V}, I_D = 30\text{A}, V_{\text{GS}} = 10\text{V}$ | | 64 | 76 | nC |
| Gate-Source Charge | Q_{gs} | | | 15 | | nC |
| Gate-Drain Charge | Q_{gd} | | | 24 | | nC |
| Drain-Source Diode Characteristics and Maximum Ratings | | | | | | |
| Drain-Source Diode Forward Current | I_S | | | | 57 | A |
| Drain-Source Diode Forward Voltage ^b | V_{SD} | $V_{\text{GS}} = 0\text{V}, I_S = 57\text{A}$ | | | 1.3 | V |

Notes :

- a.Repetitive Rating : Pulse width limited by maximum junction temperature.
- b.Pulse Test : Pulse Width $\leq 300\mu\text{s}$, Duty Cycle $\leq 2\%$.
- c.Guaranteed by design, not subject to production testing.
- d.L = $700\mu\text{H}$, $I_{\text{AS}} = 29\text{A}$, $V_{\text{DD}} = 25\text{V}$, $R_G = 25\Omega$, Starting $T_J = 25^\circ\text{C}$



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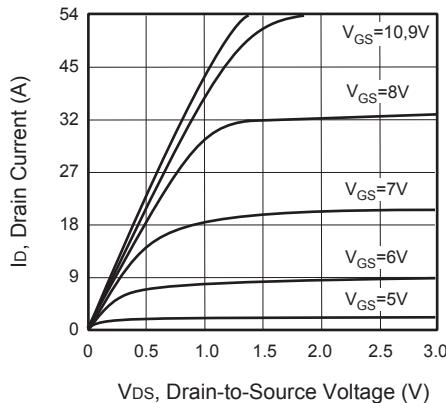


Figure 1. Output Characteristics

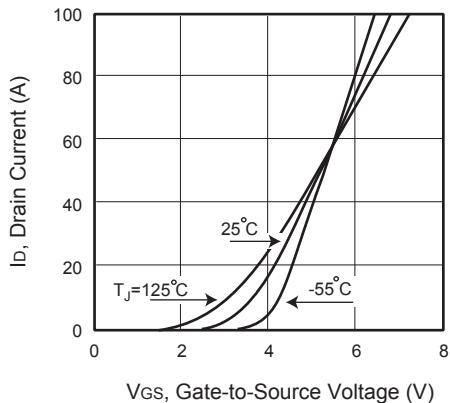


Figure 2. Transfer Characteristics

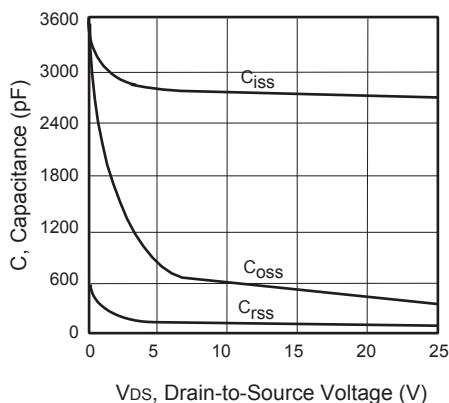


Figure 3. Capacitance

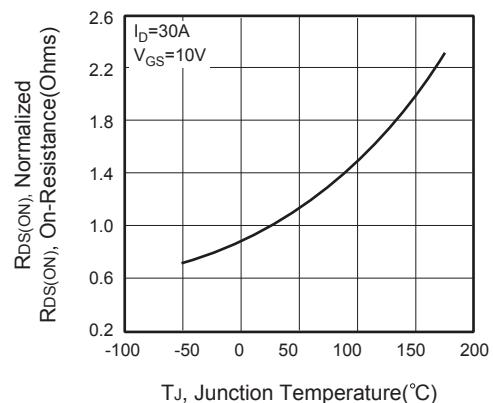


Figure 4. On-Resistance Variation with Temperature



Figure 5. Gate Threshold Variation with Temperature

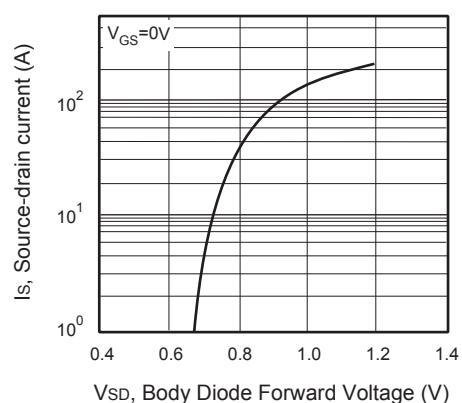


Figure 6. Body Diode Forward Voltage Variation with Source Current



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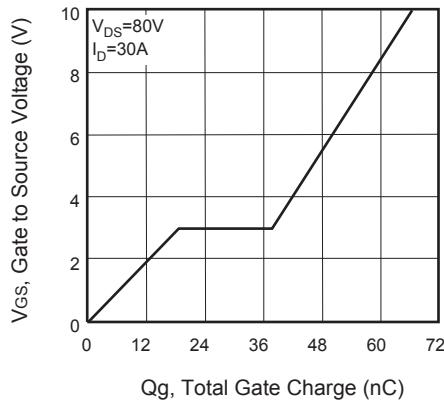


Figure 7. Gate Charge

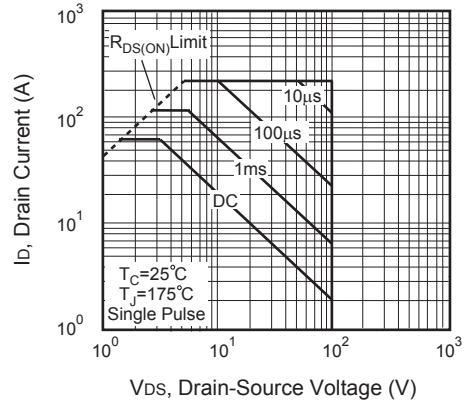


Figure 8. Maximum Safe Operating Area



Figure 9. Switching Test Circuit



Figure 10. Switching Waveforms

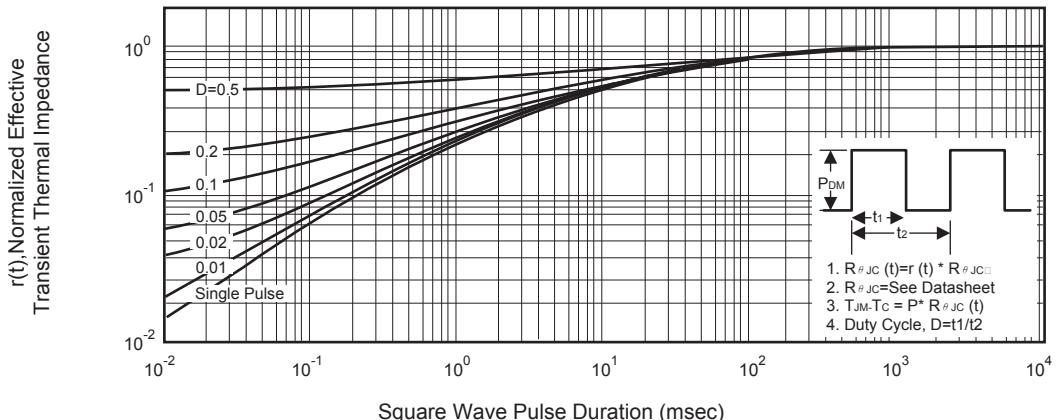


Figure 11. Normalized Thermal Transient Impedance Curve